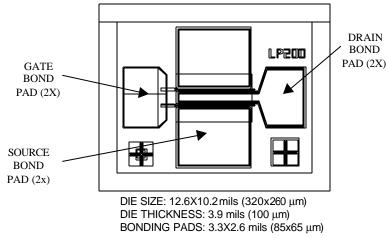


# LPD200 HIGH PERFORMANCE PHEMT

- FEATURES
  - 21 dBm Output Power at 1-dB Compression at 18 GHz
  - 12 dB Power Gain at 18 GHz
  - 1.0 dB Noise Figure at 18 GHz
  - 55% Power-Added Efficiency



## DESCRIPTION AND APPLICATIONS

The LPD200 is an Aluminum Gallium Arsenide / Indium Gallium Arsenide (AlGaAs/InGaAs) Pseudomorphic High Electron Mobility Transistor (PHEMT), utilizing an Electron-Beam direct-write 0.25  $\mu$ m by 200  $\mu$ m Schottky barrier gate. The recessed "mushroom" gate structure minimizes parasitic gate-source and gate resistances. The epitaxial structure and processing have been optimized for high dynamic range. The LPD200 also features Si<sub>b</sub>N<sub>4</sub> passivation and is available in various packages, such as ceramic P70 and other plastic packages.

Typical applications include use in low noise, broadband amplifiers.

## • ELECTRICAL SPECIFICATIONS @ T<sub>Ambient</sub> = 25°C

Parameter	Symbol	<b>Test Conditions</b>	Min	Тур	Max	Units
Saturated Drain-Source Current	I <sub>DSS</sub>	$V_{DS} = 2 V; V_{GS} = 0 V$	40	60	85	mA
Power at 1-dB Compression	P-1dB	$V_{DS} = 5 V; I_{DS} = 50\% I_{DSS}$	19	21		dBm
Power Gain at 1-dB Compression	G-1dB	$V_{DS} = 5 \text{ V};  I_{DS} = 50\%  I_{DSS}$	11	12.5		dB
Power-Added Efficiency	PAE	$V_{DS} = 5 \text{ V};  I_{DS} = 50\%  I_{DSS}$		55		%
Maximum Drain-Source Current	I <sub>MAX</sub>	$V_{DS} = 2 V; V_{GS} = 1 V$		125		mA
Transconductance	G <sub>M</sub>	$V_{DS} = 2 V; V_{GS} = 0 V$	50	70		mS
Gate-Source Leakage Current	I <sub>GSO</sub>	$V_{GS} = -5 V$		1	10	μΑ
Pinch-Off Voltage	VP	$V_{DS} = 2 V; I_{DS} = 1 mA$	-0.25	-0.8	-1.5	V
Gate-Source Breakdown Voltage Magnitude	V <sub>BDGS</sub>	$I_{GS} = 1 \text{ mA}$	-6	-7		V
Gate-Drain Breakdown Voltage Magnitude	V <sub>BDGD</sub>	$I_{\rm GD} = 1 \ mA$	-8	-9		V
Thermal Resistivity	$\Theta_{\rm JC}$			260		°C/W

frequency=18 GHz



## ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	<b>Test Conditions</b>	Min	Max	Units
Drain-Source Voltage	V <sub>DS</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		8	V
Gate-Source Voltage	V <sub>GS</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		-3	V
Drain-Source Current	I <sub>DS</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		2xI <sub>DSS</sub>	mA
Gate Current	I <sub>G</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		10	mA
RF Input Power	P <sub>IN</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		100	mW
Channel Operating Temperature	T <sub>CH</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		175	°C
Storage Temperature	T <sub>STG</sub>	_	-65	175	°C
Total Power Dissipation	P <sub>TOT</sub>	$T_{Ambient} = 22 \pm 3 \ ^{\circ}C$		550	mW

Notes:

- Operating conditions that exceed the Absolute Maximum Ratings could result in permanent damage to the device.
- Power Dissipation defined as:  $P_{TOT} \equiv (P_{DC} + P_{IN}) P_{OUT}$ , where
  - P<sub>DC</sub>: DC Bias Power P<sub>IN</sub>: RF Input Power

P<sub>OUT</sub>: RF Output Power

Absolute Maximum Power Dissipation to be de-rated as follows above 25°C:

 $P_{TOT} = 550 \text{mW} - (3.7 \text{mW}^{\circ}\text{C}) \text{ x } T_{HS}$ 

where  $T_{HS}$  = heatsink or ambient temperature.

### • HANDLING PRECAUTIONS

To avoid damage to the devices care should be exercised during handling. Proper Electrostatic Discharge (ESD) precautions should be observed at all stages of storage, handling, assembly, and testing. These devices should be treated as Class 1A (0-500 V). Further information on ESD control measures can be found in MIL-STD-1686 and MIL-HDBK-263.

#### ASSEMBLY INSTRUCTIONS

The recommended die attach is gold/tin eutectic solder under a nitrogen atmosphere. Stage temperature should be 280-290°C; maximum time at temperature is one minute. The recommended wire bond method is thermo-compression wedge bonding with 0.7 or 1.0 mil (0.018 or 0.025 mm) gold wire. Stage temperature should be 250-260°C.

#### • APPLICATIONS NOTES & DESIGN DATA

Applications Notes are available from your local Filtronic Sales Representative or directly from the factory. Complete design data, including S-parameters, noise data, and large-signal models are available on the Filtronic web site.